

Special Issue

Nanomaterial Design and Fabrication for Enhanced Mechanical Behavior

Message from the Guest Editor

We are inviting submissions to this Special Issue on Research on Mechanical Behavior of Nanomaterials. One of the most important performance indicators of nanomaterials is their mechanical properties. Novel nanomaterials that are stronger, tougher, and lighter are always desired in materials science and engineering applications. In this Special Issue, we invite submissions exploring cutting-edge research and recent advances in the fields of nanomaterials (such as large-scale composite materials, alloy nanomaterials, nano-metal, nano-nonmetal, nano-polymer materials, metallic oxides, and so on) with advanced mechanical behaviors. Both theoretical and experimental studies are welcome, as well as comprehensive review and survey papers.

Guest Editor

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Deadline for manuscript submissions

closed (25 September 2024)



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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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